$\backslash$	10	9	8	7	6	5	4	З	2	1	
l ì					•				•		í

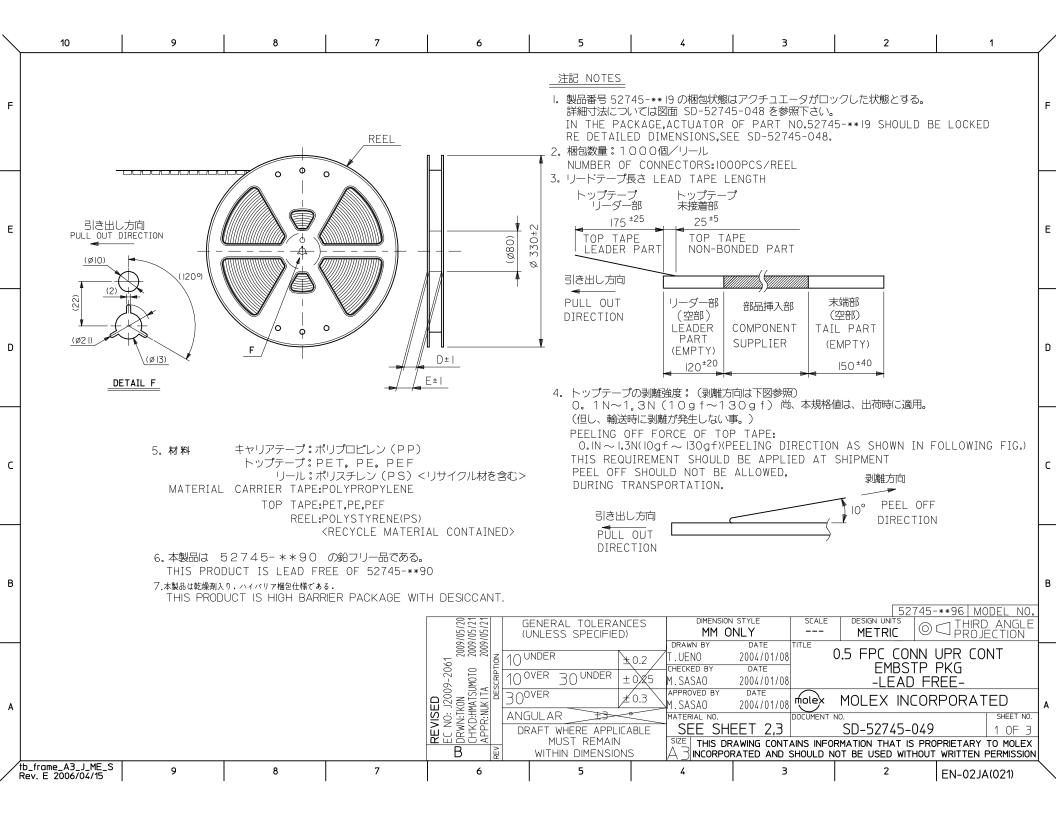
F

С



F	C     D       (2.4)     (A)       (2.4)     (A)       (2.4)     (A)       (1)     (A)       (1)     (C)	<ul> <li>・使用材料 MATERIAL</li> <li>ハウジング :ボリアミド46、ガラス充填、UL94V-0(白) HOUSING POLYAMIDE46、GLASS FILLED、UL94V-0(WHITE)</li> <li>アクチュエータ :ボリフェニレンサルファイド ガラス充填、UL94V-0(BLACK)</li> <li>ターミナル :リン青銅、ニッケル下地綿ピスマスメッキ(t=0.2)</li> <li>TERMINAL PHOSPOR BRONZE,TIN-BISMUTH OVER NICKEL PLATING</li> <li>金具 :リン青銅、ニッケル下地綿線メッキ(t=0.2)</li> </ul>	F
E		FITTING NAIL PHOSPOR BRONZE,TIN OVER NICKEL PLATING 2. エンボステープ梱包時は、アクチュエータガロックした状態とする。 IN THE PACKAGE,ACTUATOR OF PART NO.52745-**19 SHOULD BE LOCKED. (本) ソルダーテール半田付け面のズレ量、及び金具半田付け面のズレ量は、基準面 H に対し上方向 O.1 MAX、下方向 O.1 5MAX、とする。 MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM H UPPER DIRECTION: O.I MAX., LOWER DIRECTION: O.I5MAX. (本) 偶数極に適用。 APPLY FOR EVEN CIRCUIT.	E
D	<u>ハウジング</u> HOUSING HOUSING I I I I I I I I I I I I I I I I I I	<ul> <li>▲ パターンはくり止め用金具 FITTING NAIL FOR PREVENTION OF PEELING OF P.C.B. PATTERN.</li> <li>6.本製品は 52745-**17 の鉛フリー品である。 THIS PRODUCT IS LEAD FREE OF 52745-**17</li> <li>▲ RO. 3は、FPCの導体部にかからないこと。 RO.3 MUST NOT BE OVERLAPPED TO PATTERN OF FPC.</li> </ul>	D
_	(0.9) (0.9) 回路番号1用 マーフ CKT.NO.1 MARK (0.9) B <sup>±0.1</sup> (0.9) CKT.NO.1 MARK (0.9) (0.7) (0.5) (0	16.1       14.3       10.65       9.5       52745-2096       52745-2019       20         15.6       13.8       10.15       9.0       -1996       -1919       19         15.1       13.3       9.65       8.5       -1896       -1819       18         14.6       12.8       9.15       8.0       -1796       -1719       17         14.1       12.3       8.65       7.5       -1696       -1619       16         13.6       11.8       8.15       7.0       -1596       -1519       15         13.1       11.3       7.65       6.5       -1496       -1419       14	
c		12.6       10.8       7.15       6.0       -1396       -1319       13         12.1       10.3       6.65       5.5       -1296       -1219       12         11.6       9.8       6.15       5.0       -1196       -1119       11         11.1       9.3       5.65       4.5       -1096       -1019       10         10.6       8.8       5.15       4.0       -0996       -0919       9         10.1       8.3       4.65       3.5       -0896       -0819       8         9.6       7.8       4.15       3.0       /       -0796       /       -0719       7	
в	L L L L ULNERAL TULLRANCES	9.1     7.3     3.65     2.5     ✓     -0696     ✓     -0619     6       8.1     6.3     2.65     1.5     52745-0496     52745-0419     4       D     C     B     (A)     EMBOSSED TAPE ORDER No. *-*-##     MATERIAL NO. CIRCUIT       1     52745-**19     MODEL NO.       1     SCALE     DESIGN UNITS     THIRD ANGLE	В
A	OPPORT       TORAWN E	MM ONLY      METRIC     PROJECTION       Y     DATE     '04/01/28     0.5     FPC CONN ASSY ZIF       BY     DATE     UPR CONT       0     '04/01/28     -LEAD FREE-       DATE     '04/01/28     MOLEX INCORPORATED       NO.     DOCUMENT NO.     SHEET NO.	A
/t F	b_frame_A3_J_ME_S 9 8 7 6 5 4	EE TABLE     SD-52745-048     1 OF 2       HIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX. ORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION       3     2       BN-02JA(021)	

$\searrow$	10	9	8	7	6	5	4	3	2	1
F		3.65	0.5(N-1) 3.65			0.5 <sup>±0.1</sup> 0.5 <sup>±0.05</sup>		0.5 <sup>±0.08</sup>		<u>0.5<sup>±0.08</sup></u> 0.3 <sup>±0.03</sup>
E	(公差非緊			(2:0) (2:0)	20 20		2-R0.3 2-R0.3 (新設計) (311FFEMER BOARD)	▲ (ビッチ) (PITCH) (PITCH)		6 <sup>±0.5</sup> (補強板) (STIFFENER BOARD)
D			基板レイアウト マウント面) IOMMENDED P.C.BOARD TERN DIMENSION (REF.) MOUNTING SIDE)							(STIF
с	PATTERN		パタ 半田 KEE PAT	0.45 MAX. -ンおよび 禁止エリア PING OUT AREA OF TERN AND SOLDERING	0.55 MAX.	適合FPC推奨 APPLICABLE <u>RECOMMENDED DIM</u> (仕上がり厚さ: (THICKNESS: FPCについて: 打抜き方向は導体 補強フィルム材質	0.3 <sup>±0.03</sup> ) 0.3 <sup>±0.03</sup> ) 側から補強板側を推奨致し はポリイミドを推奨致しる	(仕上 (TH	AFFC推奨寸法 APPLICABLE_FFC MMENDED DIMENSION ゴルリ厚さ:0.3 <sup>±0.03</sup> ) ICKNESS:0.3 <sup>±0.03</sup> )	
	BOARD	R 0.3 (0.605) (FROM PATTERN	金具パタ A EDGE) SOLDER OF FITT	-VIU7 ING AREA ING NAL	(0.3)	按有机品类吸收化按 ABOUT FPC: RECOMMENDED PUN RECOMMENDED MAT STIF BONI	着剤を推奨致します。 CHER DIRECTION :FROM C ERIAL : 'FENER FILM :POLYIMIDE DING AGENT :THERMOSETT	ONDUCTOR SIDE TO STIFF ING BONDING AGENT	ENER BOARD SIDE.	-
В	= (DETAIL	<u>(IEW M</u> OF FITTING NAIL I PATTERN)			€ 4 L	GENERAL TOLERANO (UNLESS SPECIFIED)		N STYLE SCALE	52745	5-**19 MODEL NO. THIRD ANGLE PROJECTION
A					REVISED EC NO: J2011-0806 DRWN.JEBISAM 2010/12/1 CHYCD:KTAKHASHI 2010/12/1 APPR:KMORIKAM 2010/12/1 REV DESCRIPTION	10 <sup>UNDER</sup> ± 10 <sup>OVER</sup> 30 <sup>UNDER</sup> ± 30 <sup>OVER</sup> ± ANGULAR ±3 DRAFT WHERE APPLICA MUST REMAIN	DRAWN BY           0.2         T. UENO           CHECKED BY         CHECKED BY           0.25         M.SASAO           0.3         APPROVED BY           M.SASAO         MATERIAL NO.           ABLE         SEE SI	DATE '04/01/28 DATE '04/01/28 DATE '04/01/28 DOCUMENT TEET 1 DOCUMENT	0.5 FPC CONN UPR CC -LEAD F MOLEX INCO SD-52745-048	ASSY ZIF DNT REE- RPORATED
T F	b_frame_A3_J_ME_S Rev. E 2006/04/15	9	8	7	6	5	4	3	2	EN-02JA(021)



$\searrow$	10	9	8	7	6	5	4	З	2	1	
F											F
E		トッフ TOP	<u>プテープ (2</u> TAPE	(6.1) PL 2.45) (2.45)	引き出し方向 JLL OUT DIRECTIO	N 52745-**19		(0.5)	9)		E
D			±0.05 4 <sup>±0.3</sup> • 5 <sup>±0.05</sup> • 5 <sup>±0.05</sup>			ロー モンチ 40 <sup>±0.2</sup> UMULATIVE CH 40 <sup>±0.2</sup>		(0.5) SEC	<u>T.X-X</u>		D
с		<u>SECT.</u>	_ /		<u>ァリアテープ</u>						с
в					121 121	ENERAL TOLERAN	キャリアテープ幅 CARRIER TAPE WIDTH	21.4 17.4 17.5 E D (C)	(B) (A) MAT	745-0496 4 ERIAL NO。 檀数 circuit 5-**96 MODEL NO 了 THIRD ANGLE	).
A					<b>1/SED</b> 10: J2009-2061 10: J2009-2061 10: J2009-2061 10: J2009/05 2: UNKITA 2: UNKITA 2: 2: 09/05 0: 00/05 0: 00/05	UNLESS SPECIFIED)	) MM DRAWN BY T.UENO CHECKED BY ± 0.2 M.SASA0 40.3 APPROVED BY M.SASA0 MATERIAL NO. ABLE SIZE THIS	ONLY            DATE         TITLE           2004/01/08         DATE           DATE         DATE           2004/01/08         DOCUMENT           TABLE         DOCUMENT           DRAWING CONTAINS INF         DOCUMENT           DRAWING CONTAINS INF         DOCUMENT	0.5 FPC CONN EMBSTP -LEAD F MOLEX INCOF SD-52745-049	PKG REE- RPORATED 2 OF 3	A
F	b_frame_A3_J_ME_S Rev. E 2006/04/15	9	8	7	6	5	4	3	2	EN-02JA(021)	

$\mathbf{r}$	10	9	8	7	6	5	4		З		2		1
F		<u>トップ</u>			き出し方向 DUT DIRECTION 527	45-**  9							
E		TOP	24*0.3										
D				(2) (2) (2) (2) (2) (2) (2) (2) (2) (2)	↓	<u>₹ 40</u> *0.2 ATIVE 0*0.2				17.4 10. 16.9 10. 16.4 9.3 15.9 9.3	3     15.9       3     15.4       3     14.9	52745-2096 - 1996 - 1896 - 1796	20 19 18 17
с		(0.	(4.9)	<u>24mm幅キャリ</u> 24mm WIDTH CARI (0.5)			24	29.4	25.4	15.4         8.8           14.9         8.3           14.4         7.8           13.9         7.3           13.4         6.8           12.9         6.3           12.4         5.8           11.9         5.3	3     13.9       3     13.4       3     12.9       3     12.4       3     11.9       3     11.4	- 1696 - 1596 - 1496 - 1396 - 1296 - 1196 - 1096 - 0996	I6       I5       I4       I3       I2       I1       I0       9
в		(0.5) (2.4)	<u>SECT.X-X</u>				キヤリアテープ幅 CARRIER TAPE WIDTH	E	D	11.4     4.8       0.9     4.3       0.4     3.8       (C)     (B)	3     IO.4       3     9.9       3     9.4       )     (A)	-0896 -0796 52745-0696 MATERIAL NO. 52745-**96  MC	8 7 6 極数 circuit
A					REVISED           EC NO: J2009-2061           DRWN:TK0N           DRWN:TK0N           CHYKD:HMATSUMOT0           ZAPPR:NUKTA           DRPR:NUKTA           DIAPR:SUMOT0           Z007/05           APPR:NUKTA           DIAPR:SUMOT0           Z007/05	ENERAL TOLERA JNLESS SPECIFIE JNDER DVER JULAR RAFT WHERE APPL MUST REMAIN	D) DRAWN BY DRAWN BY DRAWN BY T. UENO CHECKED B ±0.2 CHECKED B CHECKED S CHECKED S CHECK	20 Y 20 BY 20 IO. E TAI	Y DATE T 004/01/08 DATE 004/01/08 DATE 004/01/08 BL F	TOLEX M	METRIC 5 FPC CC EMB: -LEA 10LEX IN	© ⊂ THIRD PROJE DNN UPR COI STP PKG D FREE- NCORPORAT	ANGLE CTION NT ED SHEET NO. 3 OF 3
/tt R	b_frame_A3_J_ME_S Rev. E 2006/04/15	9	8	7	B ≧ 6	WITHIN DIMENSIO		RPORAT	ED AND SH	HOULD NOT	BE USED W	IS PROPRIETARY	PERMISSION

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